

# DATA SHEET

# **SA605**

High performance low power mixer FM IF system

Product specification Replaces data of November 3, 1992 RF Communications Handbook

1997 Nov 07

# **Philips Semiconductors**





### High performance low power mixer FM IF system

**SA605** 

#### DESCRIPTION

The SA605 is a high performance monolithic low-power FM IF system incorporating a mixer/oscillator, two limiting intermediate frequency amplifiers, quadrature detector, muting, logarithmic received signal strength indicator (RSSI), and voltage regulator. The SA605 combines the functions of Signetics' SA602 and SA604A, but features a higher mixer input intercept point, higher IF bandwidth (25MHz) and temperature compensated RSSI and limiters permitting higher performance application. The SA605 is available in 20-lead dual-in-line plastic, 20-lead SOL (surface-mounted miniature package) and 20-lead SSOP (shrink small outline package).

The SA605 and SA615 are functionally the same device types. The difference between the two devices lies in the guaranteed specifications. The SA615 has a higher  $I_{CC}$ , lower input third order intercept point, lower conversion mixer gain, lower limiter gain, lower AM rejection, lower SINAD, higher THD, and higher RSSI error than the SA605. Both the SA605 and SA615 devices will meet the EIA specifications for AMPS and TACS cellular radio applications.

For additional technical information please refer to application notes AN1994, 1995 and 1996, which include example application diagrams, a complete overview of the product, and artwork for reference.

### **APPLICATIONS**

- Cellular radio FM IF
- High performance communications receivers
- Single conversion VHF/UHF receivers
- SCA receivers
- RF level meter
- Spectrum analyzer
- Instrumentation
- FSK and ASK data receivers
- Log amps
- Wideband low current amplification

### **PIN CONFIGURATION**

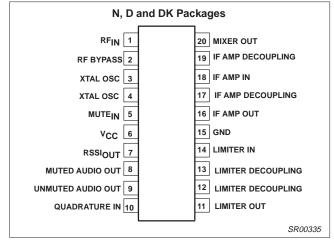


Figure 1. Pin Configuration

### **FEATURES**

- Low power consumption: 5.7mA typical at 6V
- Mixer input to >500MHz
- Mixer conversion power gain of 13dB at 45MHz
- Mixer noise figure of 4.6dB at 45MHz
- XTAL oscillator effective to 150MHz (L.C. oscillator to 1GHz local oscillator can be injected)
- 102dB of IF Amp/Limiter gain
- 25MHz limiter small signal bandwidth
- Temperature compensated logarithmic Received Signal Strength Indicator (RSSI) with a dynamic range in excess of 90dB
- Two audio outputs muted and unmuted
- Low external component count; suitable for crystal/ceramic/LC filters
- Excellent sensitivity: 0.22μV into 50Ω matching network for 12dB SINAD (Signal to Noise and Distortion ratio) for 1kHz tone with RF at 45MHz and IF at 455kHz
- SA605 meets cellular radio specifications
- ESD hardened

### ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
20-Pin Plastic Dual In-Line Package (DIP)	−40 to +85°C	SA605N	SOT146-1
20-Pin Plastic Small Outline Large (SOL) package	−40 to +85°C	SA605D	SOT163-1
20-Pin Plastic Shrink Small Outline Package (SSOP)	−40 to +85°C	SA605DK	SOT266-1

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### **BLOCK DIAGRAM**

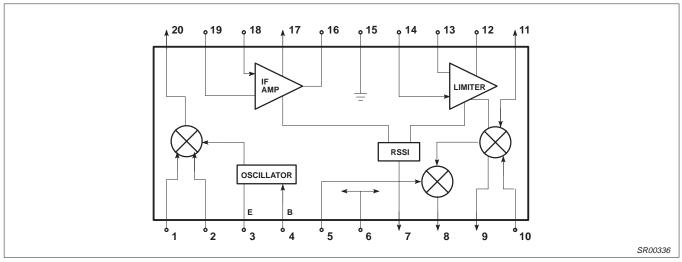


Figure 2. Block Diagram

### **ABSOLUTE MAXIMUM RATINGS**

SYMBOL	PARAMETER	RATING	UNITS
V <sub>CC</sub>	Single supply voltage	9	V
T <sub>STG</sub>	Storage temperature range	-65 to +150	°C
T <sub>A</sub>	Operating ambient temperature range SA605	-40 to +85	°C
$\theta_{\sf JA}$	Thermal impedance D package N package SSOP package	90 75 117	°C/W

### DC ELECTRICAL CHARACTERISTICS

 $V_{CC}$  = +6V,  $T_A$  = 25°C; unless otherwise stated.

				LIMITS					
SYMBOL	PARAMETER	TEST CONDITIONS		UNITS					
			MIN	TYP	MAX				
V <sub>CC</sub>	Power supply voltage range		4.5		8.0	V			
I <sub>CC</sub>	DC current drain		4.55	5.7	6.55	mA			
	Mute switch input threshold (ON)		1.7			V			
	(OFF)				1.0	V			

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### **AC ELECTRICAL CHARACTERISTICS**

 $T_A = 25^{\circ}\text{C}$ ;  $V_{CC} = +6\text{V}$ , unless otherwise stated. RF frequency = 45MHz + 14.5dBV RF input step-up; IF frequency = 455kHz; R17 = 5.1k; RF level = -45dBm; FM modulation = 1kHz with  $\pm 8\text{kHz}$  peak deviation. Audio output with C-message weighted filter and de-emphasis capacitor. Test circuit Figure 3. The parameters listed below are tested using automatic test equipment to assure consistent electrical characterristics. The limits do not represent the ultimate performance limits of the device. Use of an optimized RF layout will improve many of the listed parameters.

				LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS		SA605		UNITS
			MIN	MIN TYP MA		]
Mixer/Osc s	ection (ext LO = 300mV)	-				
f <sub>IN</sub>	Input signal frequency			500		MHz
fosc	Crystal oscillator frequency			150		MHz
	Noise figure at 45MHz			5.0		dB
	Third-order input intercept point	f1 = 45.0; f2 = 45.06MHz		-10		dBm
	Conversion power gain	Matched 14.5dBV step-up	10	13	15	dB
		50Ω source		-1.7		dB
	RF input resistance	Single-ended input	3.0	4.7		kΩ
	RF input capacitance			3.5	4.0	pF
	Mixer output resistance	(Pin 20)	1.25	1.5		kΩ
IF section	•	•				
	IF amp gain	50Ω source		39.7		dB
	Limiter gain	50Ω source		62.5		dB
	Input limiting -3dB, R <sub>17</sub> = 5.1k	Test at Pin 18		-113		dBm
	AM rejection	80% AM 1kHz	29	34	43	dB
	Audio level, R <sub>10</sub> = 100k	15nF de-emphasis	80	150	260	mV <sub>RMS</sub>
	Unmuted audio level, R <sub>11</sub> = 100k	150pF de-emphasis		480		mV
	SINAD sensitivity	RF level -118dB		16		dB
THD	Total harmonic distortion		-34	-42		dB
S/N	Signal-to-noise ratio	No modulation for noise		73		dB
	IF RSSI output, $R_9 = 100k\Omega^1$	IF level = -118dBm	0	160	650	mV
		IF level = -68dBm	1.9	2.5	3.1	V
		IF level = -18dBm	4.0	4.8	5.6	V
	RSSI range	$R_9 = 100 k\Omega \text{ Pin } 16$		90		dB
	RSSI accuracy	$R_9 = 100 k\Omega \text{ Pin } 16$		<u>+</u> 1.5		dB
	IF input impedance		1.40	1.6		kΩ
	IF output impedance		0.85	1.0		kΩ
	Limiter input impedance		1.40	1.6		kΩ
	Unmuted audio output resistance			58		kΩ
	Muted audio output resistance			58		kΩ
RF/IF sectio	n (int LO)	-	-			-
	Unmuted audio level	4.5V = V <sub>CC</sub> , RF level = -27dBm		450		mV <sub>RMS</sub>
	System RSSI output	4.5V = V <sub>CC</sub> , RF level = -27dBm		4.3		V

#### NOTE:

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<sup>1.</sup> The generator source impedance is 50Ω, but the SA605 input impedance at Pin 18 is 1500Ω. As a result, IF level refers to the actual signal that enters the SA605 input (Pin 8) which is about 21dB less than the "available power" at the generator.

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### **CIRCUIT DESCRIPTION**

The SA605 is an IF signal processing system suitable for second IF or single conversion systems with input frequency as high as 1GHz. The bandwidth of the IF amplifier is about 40MHz, with 39.7dB(v) of gain from a  $50\Omega$  source. The bandwidth of the limiter is about 28MHz with about 62.5dB(v) of gain from a  $50\Omega$  source. However, the gain/bandwidth distribution is optimized for  $455\text{kHz}, 1.5\text{k}\Omega$  source applications. The overall system is well-suited to battery operation as well as high performance and high quality products of all types.

The input stage is a Gilbert cell mixer with oscillator. Typical mixer characteristics include a noise figure of 5dB, conversion gain of 13dB, and input third-order intercept of -10dBm. The oscillator will operate in excess of 1GHz in L/C tank configurations. Hartley or Colpitts circuits can be used up to 100MHz for xtal configurations. Butler oscillators are recommended for xtal configurations up to 150MHz.

The output of the mixer is internally loaded with a  $1.5k\Omega$  resistor permitting direct connection to a 455kHz ceramic filter. The input resistance of the limiting IF amplifiers is also  $1.5k\Omega$ . With most 455kHz ceramic filters and many crystal filters, no impedance matching network is necessary. To achieve optimum linearity of the log signal strength indicator, there must be a 12dB(v) insertion loss between the first and second IF stages. If the IF filter or interstage

network does not cause 12dB(v) insertion loss, a fixed or variable resistor can be added between the first IF output (Pin 16) and the interstage network.

The signal from the second limiting amplifier goes to a Gilbert cell quadrature detector. One port of the Gilbert cell is internally driven by the IF. The other output of the IF is AC-coupled to a tuned quadrature network. This signal, which now has a  $90^{\circ}$  phase relationship to the internal signal, drives the other port of the multiplier cell.

Overall, the IF section has a gain of 90dB. For operation at intermediate frequencies greater than 455kHz, special care must be given to layout, termination, and interstage loss to avoid instability.

The demodulated output of the quadrature detector is available at two pins, one continuous and one with a mute switch. Signal attenuation with the mute activated is greater than 60dB. The mute input is very high impedance and is compatible with CMOS or TTL levels.

A log signal strength completes the circuitry. The output range is greater than 90dB and is temperature compensated. This log signal strength indicator exceeds the criteria for AMPs or TACs cellular telephone.

NOTE:  $dB(v) = 20log V_{OUT}/V_{IN}$ 

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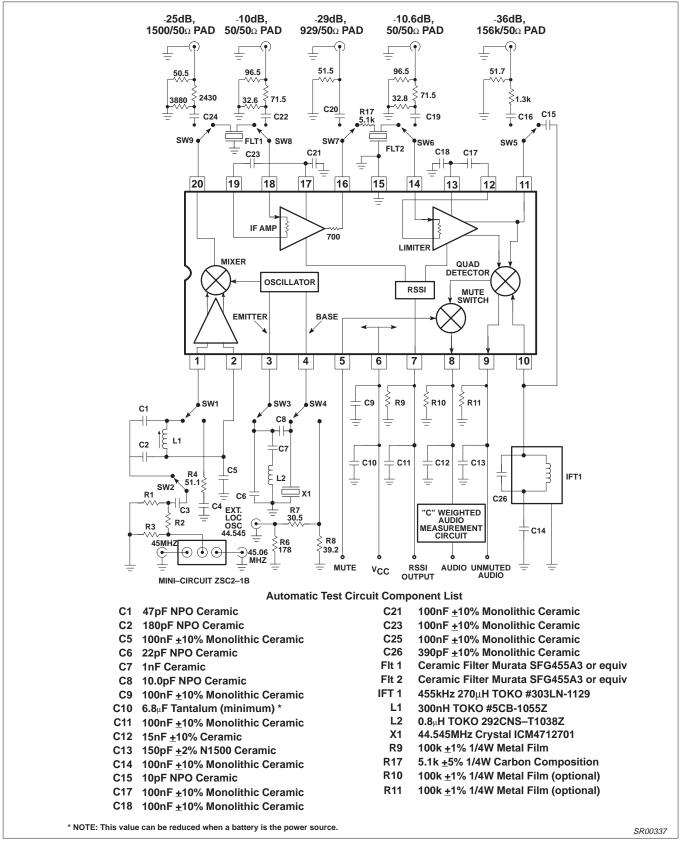


Figure 3. SA605 45MHz Test Circuit (Relays as shown)

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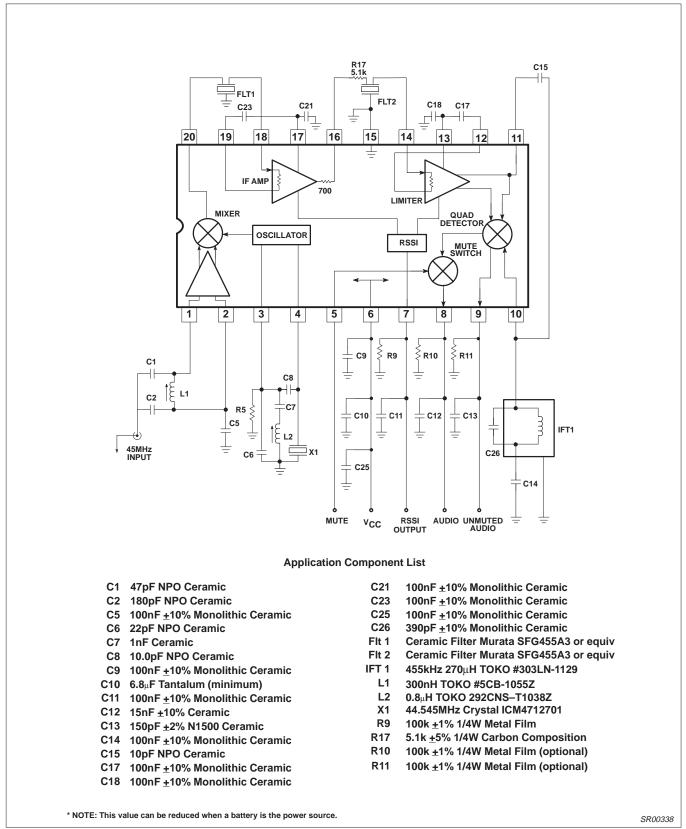


Figure 4. SA605 45MHz Application Circuit

### High performance low power mixer FM IF system

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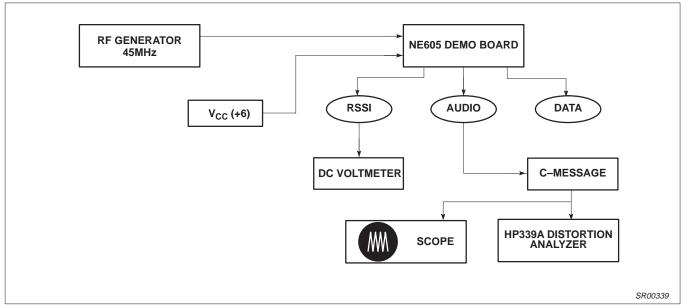


Figure 5. SA605 Application Circuit Test Set Up

#### NOTES:

- 1. C-message: The C-message filter has a peak gain of 100 for accurate measurements. Without the gain, the measurements may be affected by the noise of the scope and HP339 analyzer.
- Ceramic filters: The ceramic filters can be 30kHz SFG455A3s made by Murata which have 30kHz IF bandwidth (they come in blue), or 16kHz CFU455Ds, also made by Murata (they come in black). All of our specifications and testing are done with the more wideband filter.
- 3. RF generator: Set your RF generator at 45.000MHz, use a 1kHz modulation frequency and a 6kHz deviation if you use 16kHz filters, or 8kHz if you use 30kHz filters.
- 4. Sensitivity: The measured typical sensitivity for 12dB SINAD should be 0.22μV or -120dBm at the RF input.
- 5. Layout: The layout is very critical in the performance of the receiver. We highly recommend our demo board layout.
- 6. RSSI: The smallest RSSI voltage (i.e., when no RF input is present and the input is terminated) is a measure of the quality of the layout and design. If the lowest RSSI voltage is 250mV or higher, it means the receiver is in regenerative mode. In that case, the receiver sensitivity will be worse than expected.
- Supply bypass and shielding: All of the inductors, the quad tank, and their shield must be grounded. A 10-15μF or higher value tantalum capacitor on the supply line is essential. A low frequency ESR screening test on this capacitor will ensure consistent good sensitivity in production. A 0.1μF bypass capacitor on the supply pin, and grounded near the 44.545MHz oscillator improves sensitivity by 2-3dB.
- R5 can be used to bias the oscillator transistor at a higher current for operation above 45MHz. Recommended value is 22kΩ, but should not be below 10kΩ.

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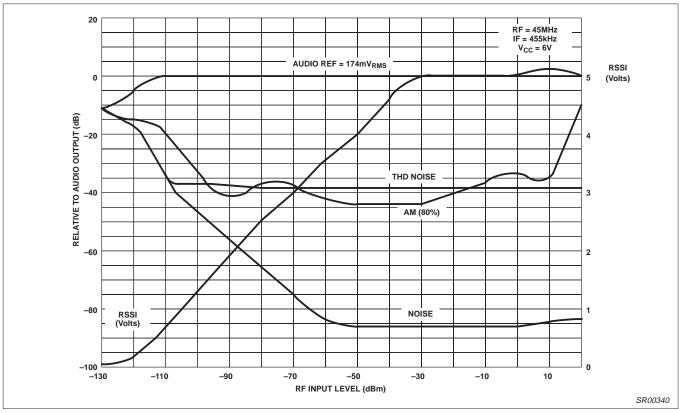
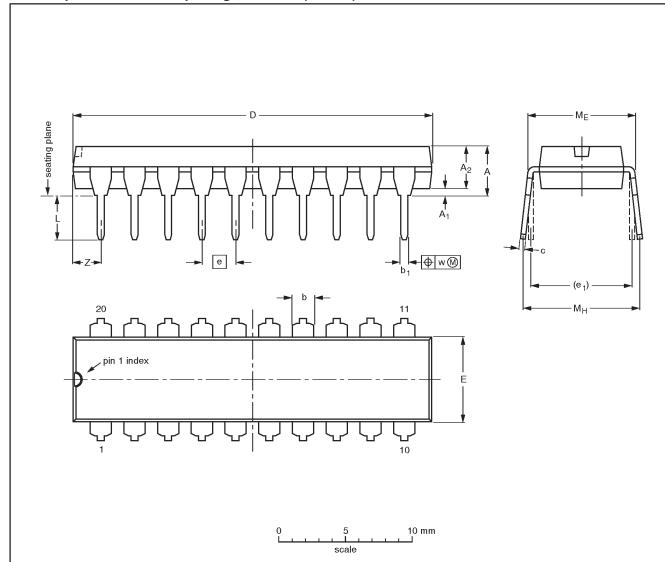


Figure 6. SA605 Application Board at 25°C

**SA605** 

### DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.0
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

#### Note

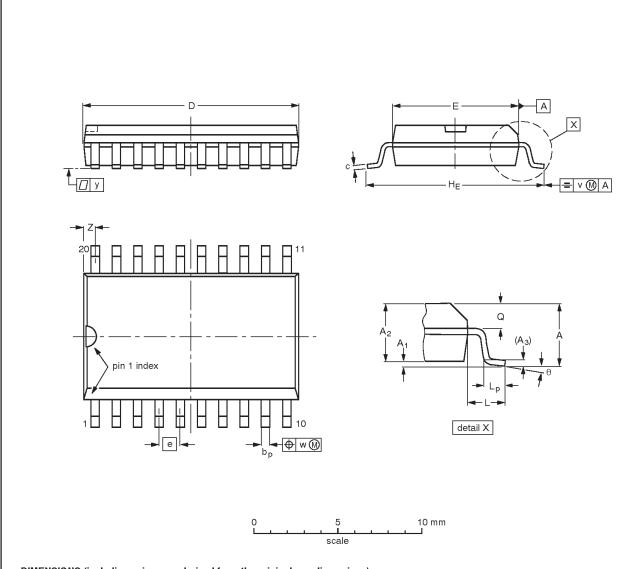
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT146-1			SC603			<del>92-11-17</del> 95-05-24	

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### SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	O	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	ø	٧	w	у	z <sup>(1)</sup>	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

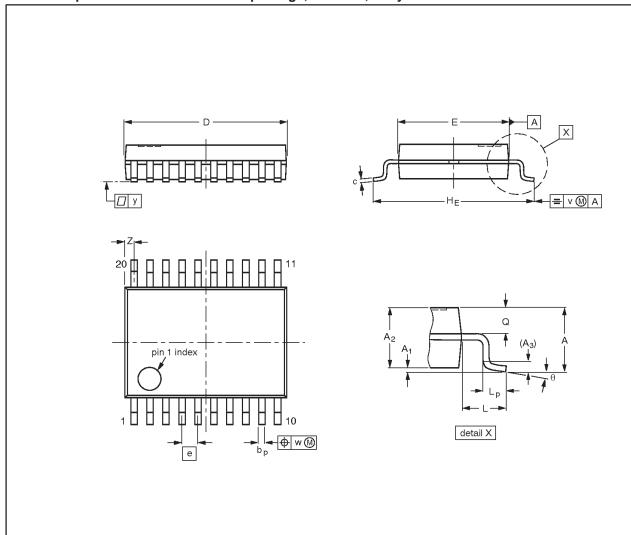
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT163-1	075E04	MS-013AC			<del>-92-11-17</del> 95-01-24	

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### SSOP20: plastic shrink small outline package; 20 leads; body width 4.4 mm

SOT266-1



### **DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.5	0.15 0	1.4 1.2	0.25	0.32 0.20	0.20 0.13	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.45	0.65 0.45	0.2	0.13	0.1	0.48 0.18	10° 0°

5 mm

#### Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT266-1						<del>-90-04-05</del> 95-02-25

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	DEFINITIONS									
Data Sheet Identification	Product Status	Definition								
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.								
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Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.								

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